



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: 1771

Examiner: Norca L. Torres-Velazquez

Inventor: Gregory L. Todt

Serial No. 10/079,642

Filed: February 20, 2002

For: Material For Protecting Articles Having A  
Nonwoven Fabric Bonded To A Shrink  
Film By An Adhesive Applied In A  
Predetermined Pattern

**TERMINAL  
DISCLAIMER**

Commissioner For Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

1. Transshield Technology AS, the owner of the present above-identified application as well as the owner of U.S. Patent No. 6,562,740, hereby disclaims and dedicates to the public the term of any patent which issues from the present application which extends beyond the expiration date of said U.S. Patent No. 6,562,740.

2. Transshield Technology AS further agrees and acknowledges that any patent granted on the present application shall be enforceable only for and during the period that said patent is commonly owned with said U.S. Patent No. 6,562,740.

3. Transshield Technology AS does not disclaim any terminal part of any patent granted on the above-identified application prior to the expiration date of the full statutory term of U.S. Patent No. 6,562,740 in the event that it: expires for failure to pay a maintenance fee, is held unenforceable, is found invalid, is statutorily disclaimed in whole or terminally disclaimed under 37 C.F.R. 1.321(a),

has all claims cancelled by a reexamination certificate, or is otherwise terminated prior to the expiration of its statutory term, except for the separation of legal title stated above.

Robert M. Siminski hereby declares that he is the appointed attorney for Transshield Technology AS and is properly authorized to execute this document on their behalf; that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Respectfully submitted,

Date:

March 23, 2004



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